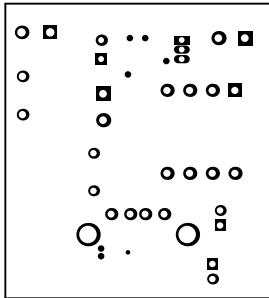
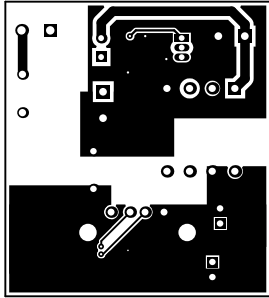


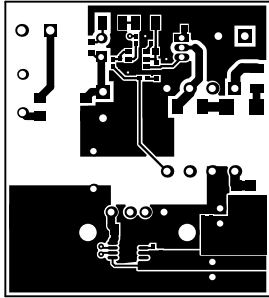
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9594	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 2/25/2014 8:28:46 AM	TEXAS INSTRUMENTS	



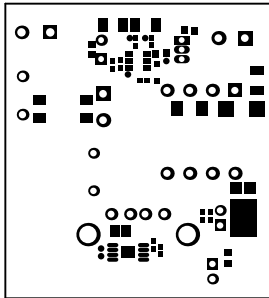
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9594	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 2/25/2014 8:28:47 AM	TEXAS INSTRUMENTS	



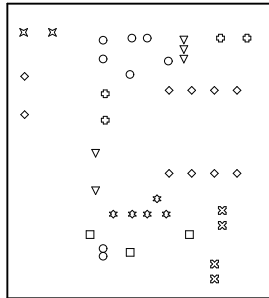
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9594	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 2/25/2014 8:28:48 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9594	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 2/25/2014 8:28:49 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9594	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 2/25/2014 8:28:49 AM	TEXAS INSTRUMENTS	

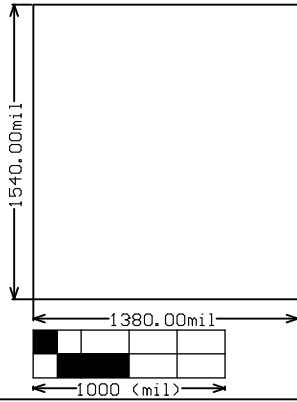


Symbol	Hit Count	Tool Size	Physical Length	Rout Path Length	Plated	Hole Type
□	1	7.874mil (0.2mm)			PTH	Round
○	6	12mil (0.305mm)			PTH	Round
▽	3	29.528mil (0.75mm)			PTH	Round
◇	2	31mil (0.787mm)			PTH	Round
⊗	4	33mil (0.838mm)			PTH	Round
▽	2	33.465mil (0.85mm)			PTH	Round
☆	4	36.221mil (0.92mm)			PTH	Round
◇	10	37.402mil (0.95mm)			PTH	Round
⊗	4	39.37mil (1mm)			PTH	Round
⊗	2	43.307mil (1.1mm)			PTH	Round
□	2	90.551mil (2.3mm)			PTH	Round
☆	1	60mil (1.524mm)	440mil (11.176mm)	380mil (9.652mm)	PTH	Slot
	41 Total					

Slot definitions : Rout Path Length = Calculated from tool start centre position to tool end centre position.
 Physical Length = Rout Path Length + Tool Size = Slot length as defined in the PCB layout

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9594	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 2/25/2014 8:28:51 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9594	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 2/25/2014 8:28:52 AM	TEXAS INSTRUMENTS	

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